Axial, Molded, X7R Dielectric, 50 - 100 VDC (Commercial Grade)



Overview

KEMET's epoxy molded axial through-hole ceramic capacitors in X7R dielectric feature a 125°C maximum operating temperature. The Electronics Industries Alliance (EIA) characterizes X7R dielectric as a Class II "temperature stable" material. Components of this classification are fixed, ceramic dielectric capacitors suited for bypass and decoupling applications or for frequency

discriminating circuits where Q and stability of capacitance characteristics are not critical. X7R exhibits a predictable change in capacitance with respect to time and voltage and boasts a minimal change in capacitance with reference to ambient temperature. Capacitance change is limited to ±15% from -55°C to +125°C. These devices meet the flame test requirements outlined in UL Standard 94 V-0.

Benefits

- · Axial through-hole form factor
- Molded case
- -55°C to +125°C operating temperature range
- X7R temperature stable dielectric
- DC voltage ratings of 50 V and 100 V
- Capacitance offerings ranging from 10 pF to 3.3 μF
- Available capacitance tolerances of ±10% and ±20%
- · Non-polar device, minimizing installation concerns
- SnPb-plated lead finish (60/40)
- Encapsulation meets flammability standard UL 94 V-0

Applications

Typical applications include decoupling, bypass, filtering and transient voltage suppression.



Ordering Information

С	114	C	472	M	1	R	5	С	Α	7200
Ceramic	Style /Size	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance ¹	Rated Voltage (VDC)	Dielectric	Design	Lead Finish ²	Failure Rate	Packaging/ Grade (C-Spec)
	114 124 192 202 222	C = Standard	Two significant digits and number of zeros	K = ±10% M = ±20%	5 = 50 1 = 100	R = X7R	5 = Multilayer	C = SnPb (60/40)	A = N/A	Blank = Bulk 7200 = 12" Reel 7293 = Ammo Pack

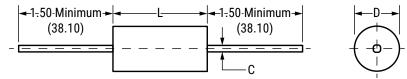
¹ Additional capacitance tolerance offerings may be available. Contact KEMET for details.

Standard: 60% tin (Sn)/40% lead (Pb) finish with 100% copper core ("C" designation). Alternative lead materials and finishes may be available. Contact KEMET for details.

² Lead materials:



Dimensions - Inches (Millimeters)



Series	Style/Size	L Length Maximum	D Diameter Maximum	LD Lead Diameter	LL Lead Length Minimum	
	114	0.160±0.010 (4.06±0.25)	0.090±0.010 (2.29±0.25)	0.020+0.0/-0.003		
C1XX	C1XX 124	0.250±0.010 (6.35±0.25)	0.090±0.010 (2.29±0.25)	(0.51+0.0/-0.08)	1.50 (38.10)	
	192	0.390±0.010 (9.91±0.25)	0.140±0.010 (3.56±0.25)	0.005.0004/.0004		
COVV	202	0.500±0.020 (12.70±0.51)	0.250±0.015 (6.35±0.38)	0.025+0.004/-0.001 (0.64+0.10/-0.025)		
C2XX	222	0.690±0.030 (17.53±0.76)	0.350±0.020 (8.89±0.51)	(0.0410.10/ 0.023)		

Application Notes

These devices are not recommended for use in overmold applications and/or processes.

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 2, Performance & Reliability.

Environmental Compliance

These devices do not meet RoHS criteria due to the concentration of Pb containment in the lead finish.



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±15%
Aging Rate (Maximum % Cap Loss/Decade Hour)	3.0%
Dielectric Withstanding Voltage	250% of rated voltage (5±1 seconds and charge/discharge not exceeding 50 mA)
Dissipation Factor (DF) Maximum Limit at 25°C	3.5%(25 V) and 2.5%(50 V to 250 V)
Insulation Resistance (IR) Limit at 25°C	1,000 megohm microfarads or 100 GΩ (Rated voltage applied for 120±5 seconds at 25°C)

Regarding aging rate: Capacitance measurements (including tolerance) are indexed to a referee time of 1,000 hours. To obtain IR limit, divide $M\Omega$ - μ F value by the capacitance and compare to $G\Omega$ limit. Select the lower of the two limits. Capacitance and dissipation factor (DF) measured under the following conditions:

1 kHz ±50 Hz and 1.0 ±0.2 V_{rms} if capacitance \leq 10 μF

120 Hz ±10 Hz and 0.5 ±0.1 V_{rms} if capacitance > 10 μF

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

High Temperature Life, Biased Humidity, Moisture Resistance						
Dielectric	Rated DC Voltage	d DC Voltage Capacitance Value DF		Capacitance Shift		
	> 25		3.0			
X7R	16/25	All	5.0	±20%		
	< 16		7.5			



Table 1A - C114 Style/Size (0.090" Diameter x 0.160" L), Capacitance Range Waterfall

C114 Style/Size (0.090" Diameter x 0.160" L)						
Rated Voltage (VDC)		50	100	200		
Voltage Code		5	1	2		
Capacitance Capacitance Tolerance		Capacitance Code (Available Capaci		capacitance)		
10pF		100	100			
12pF		120	120			
15pF		150	150			
18pF		180	180			
22pF		220	220			
27pF		270	270			
33pF		330	330			
39pF		390	390			
47pF		470	470			
56pF		560	560			
68pF		680	680			
82pF		820	820			
100pF		101	101			
120pF		121	121			
150pF		151	151			
180pF		181	181			
220pF		221	221			
270pF	4 .400	271	271			
330pF	K = ±10%	331	331			
390pF	M = ±20%	391	391			
470pF		471	471			
560pF		561	561			
680pF		681	681			
820pF		821	821			
1000pF		102	102			
1200pF		122	122			
1500pF		152	152			
1800pF		182	182			
2200pF		222	222			
2700pF		272	272			
3300pF		332	332			
3900pF		392	392			
4700pF		472	472			
5600pF		562				
6800pF		682				
8200pF		822				
0.01µF		103				
Rated Volt	age (VDC)	50	100	200		
Voltan	e Code	5	1	2		



Table 1B - C124 Style/Size (0.090" Diameter x 0.250" L), Capacitance Range Waterfall

	C124 Style/Size	(0.090" Diamete	r x 0.250" L)	
Rated Voltage ((VDC)	50	100	200
Voltage Cod	de	5	1	2
Capacitance Capacitance Tolerance		Capacitance Code (Available Capacitance)		
5600pF		562	562	
6800pF		682	682	
8200pF		822	822	
0.01µF		103	103	
0.012µF		123		
0.015µF	K = ±10%	153		
0.018µF	M = ±20%	183		
0.022µF		223		
0.027µF		273		
0.033µF		333		
0.039µF		393		
0.047μF		473		
Rated Voltage (VDC)		50	100	200
Voltage Cod	de	5	1	2

Table 1C - C192 Style/Size (0.140" Diameter x 0.390" L), Capacitance Range Waterfall

C192 Style/Size (0.140" Diameter x 0.390" L)						
Rated Voltage (VDC)		50	100	200		
Voltage Code		5	1	2		
Capacitance	Capacitance Capacitance Tolerance		citance Code (Available C	apacitance)		
0.012µF		123	123			
0.015μF		153	153			
0.018µF		183	183			
0.022µF		223	223			
0.027µF		273	273			
0.033µF		333	333			
0.039µF		393	393			
0.047µF	K = ±10%	473	473			
0.056µF	M = ±20%	563	563			
0.068µF	W - 120%	683	683			
0.082µF		823	823			
0.1µF		104	104			
0.12μF		124				
0.15μF		154				
0.18μF		184				
0.22μF		224				
0.27μF		274				
Rated Voltage (VDC)		50	100	200		
Voltage Code		5	1	2		



Table 1D - C202 Style/Size (0.250" Diameter x 0.500" L), Capacitance Range Waterfall

	C202 Style/Size	(0.250" Diamete	r x 0.500" L)	
Rated Voltage	(VDC)	50	100	200
Voltage Co	de	5	1	2
Capacitance	Capacitance Tolerance	Capa	citance Code (Available Ca	pacitance)
0.056µF		563	563	
0.068µF		683	683	
0.082µF		823	823	
0.1μF		104	104	
0.12µF		124	124	
0.15µF	K = ±10%	154	154	
0.18µF	M = ±20%	184	184	
0.22μF	IVI - 120%	224	224	
0.27μF		274	274	
0.33μF		334	334	
0.47µF		474		
0.68µF		684		
1.0µF		105		
Rated Voltage	(VDC)	50	100	200
Voltage Co	de	5	1	2

Table 1E - C222 Style/Size (0.350" Diameter x 0.690" L), Capacitance Range Waterfall

C222 Style/Size (0.350" Diameter x 0.690" L)					
Rated Voltage (VDC)		50	100	200	
Voltage Code	Voltage Code		5 1 2		
Capacitance	Capacitance Capacitance Tolerance		Capacitance Code (Available Capacitance)		
0.47µF 0.68µF 1.0µF 2.2µF 3.3µF	K = ±10% M = ±20%	474 684 105 225 335	474 684 105		
Rated Voltage (VDC) Voltage Code	Rated Voltage (VDC) Voltage Code		100	200	



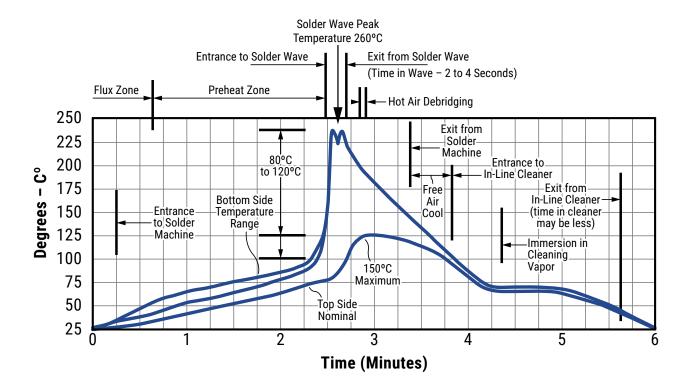
Soldering Process

Recommended Soldering Technique:

- · Solder Wave
- Hand Soldering (Manual)

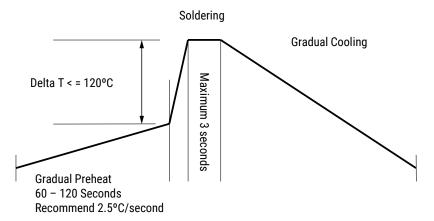
Recommended Soldering Profile:

· Optimum Wave Solder Profile



· Hand Soldering (Manual)

Manual Solder Profile with Pre-heating



KEMET recommends following the guidelines and techniques outlined in technical bulletins F2103 and F9207.



Table 2 - Performance & Reliability: Test Methods and Conditions

Stress	Reference	Test or Inspection Method
		Magnification 50 X. Conditions:
0 - 1 1 : 1 : 4	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C
Solderability	J-51D-002	b) Method B at 215°C category 3
		c) Method D, category 3 at 260°C
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C), Measurement at 24 hours. +/-2 hours after test conclusion.
	MIL-STD-202 Method	Load Humidity: 1,000 hours 85°C/85% RH and Rated Voltage. Add 100 K ohm resistor. Measurement at 24 hours. +/-2 hours after test conclusion.
Biased Humidity	103	Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours. +/-2 hours after test conclusion.
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Unpowered. Measurement at 24 hours. +/-2 hours after test conclusion.
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300. Maximum transfer time – 20 seconds. Dwell time – 15 minutes. Air – Air.
High Temperature Life	MIL-STD-202 Method 108/EIA-198	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 2 X rated voltage applied.
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC, for 1,000 hours.
Vibration	MIL-STD-202 Method 204	5 g for 20 minutes, 12 cycles each of 3 orientations. Note: Use 8"X5" PCB .031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10–2,000 Hz.
Resistance to Soldering Heat	MIL-STD-202 Method 210	Condition B. No pre-heat of samples. Note: single wave solder - procedure 2.
Terminal Strength	MIL-STD-202 Method 211	Conditions A (2.3kg or 5 lbs)
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent.

Storage & Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature-reels may soften or warp, and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C, and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts, and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within 1.5 years of receipt.



Packaging Details

Lead Spacing	Component Pitch (P1)
0.100 (2.54)	5.08
0.200 (5.08)	3.81
0.400 (10.16)	7.62
0.170 (4.32)	
0.220 (5.59)	
0.275 (6.98)	
0.300 (7.62)	
0.375 (9.52)	
0.475 (12.06)	
0.575 (14.60)	
0.675 (17.14)	

Packaging Quantities

Style/ Size	Standard Bulk Quantity	Ammo Pack Quantity Maximum	Reel Quantity Maximum (12" Reel)
114	200/Box		5000
124	200/Box		5000
192	100/Box	N/A	3000
202	25/Box		500
222	10/Tray		300

Marking

KC0G	KEMET, Temperature Characteristic
101J	Capacitance, Capacitance Tolerance
200V	Voltage
0812	——Date Code



Tape & Reel Packaging Information

KEMET offers standard reeling of molded and conformally coated axial leaded ceramic capacitors for automatic insertion or lead forming machines in accordance with EIA standard 296. KEMET's internal specification four-digit suffix, 7200, is placed at the end of the part number to designate tape and reel packaging, e.g., C410C104Z5U5CA7200.

Paper (50 lb.) test minimum is inserted between the layers of capacitors wound on reels for component pitch ≤ 0.400 ". Capacitor lead length may extend only a maximum of .0625" (1.59 mm) beyond the tapes' edges. Capacitors are centered in a row between the two tapes and will deviate only ± 0.031 " (0.79 mm) from the row center. A minimum of 36" (91.5 cm) leader tape is provided at each finished length of taped components. Universal splicing clips are used to connect the tape.



Figure 2

10.5" - 14"
(26.67 - 35.56cm)

* O59" to .315"
Greater Than Component Length

Hub

131/4"
(82.6)

Adhesive Tape

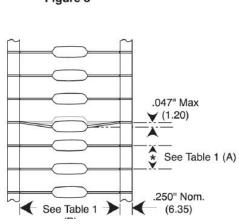


Table 3 – Ceramic Axial Tape and Reel Dimensions

Metric will govern

Dimensions — Millimeters (Inches)				
Axial Capacitor	A	B 11 5 (0.050)*		
Body Diameter	±0.5 (0.020)	±1.5 (0.059)*		
0.0 to 5.0 (0.0 to 0.197)	5.0 (0.197)	52.4 (2.062)		

Symbol Reference Table			
Α	Component Pitch		
В	Inside Tape Spacing		

^{*} Inside tape spacing dimension (B) is determined by the body diameter of the capacitor.



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